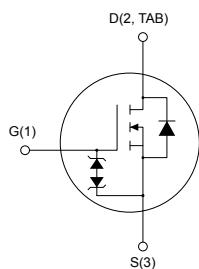
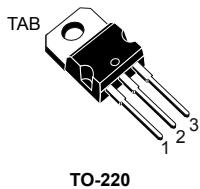


N-channel 600 V, 0.230 Ω typ., 13 A MDmesh™ M2 EP Power MOSFET in a TO-220 package

Features



Order code	V_{DS}	$R_{DS(on)}$ max.	I_D
STP20N60M2-EP	600 V	0.278 Ω	13 A

- Extremely low gate charge
- Excellent output capacitance (C_{oss}) profile
- Very low turn-off switching losses
- 100% avalanche tested
- Zener-protected

Applications

- Switching applications
- Tailored for very high frequency converters ($f > 150$ kHz)

Description

This device is an N-channel Power MOSFET developed using MDmesh™ M2 enhanced performance (EP) technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance, optimized switching characteristics with very low turn-off switching losses, rendering it suitable for the most demanding very high frequency converters.

Product status link	
STP20N60M2-EP	
Product summary	
Order code	STP20N60M2-EP
Marking	20N60M2EP
Package	TO-220
Packing	Tube

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{GS}	Gate-source voltage	± 25	V
I_D	Drain current (continuous) at $T_C = 25^\circ\text{C}$	13	A
I_D	Drain current (continuous) at $T_C = 100^\circ\text{C}$	8	A
$I_{DM}^{(1)}$	Drain current (pulsed)	52	A
P_{TOT}	Total dissipation at $T_C = 25^\circ\text{C}$	110	W
$dv/dt^{(2)}$	Peak diode recovery voltage slope	15	V/ns
$dv/dt^{(3)}$	MOSFET dv/dt ruggedness	50	V/ns
T_J	Operating junction temperature range	- 55 to 150	$^\circ\text{C}$
T_{stg}	Storage temperature range		

1. Pulse width limited by safe operating area.
2. $I_{SD} \leq 13 \text{ A}$, $di/dt \leq 400 \text{ A}/\mu\text{s}$; $V_{DS \text{ peak}} < V_{(BR)DSS}$; $V_{DD} = 400 \text{ V}$.
3. $V_{DS} \leq 480 \text{ V}$

Table 2. Thermal data

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case	1.14	$^\circ\text{C/W}$
$R_{thj-amb}$	Thermal resistance junction-ambient	62.5	$^\circ\text{C/W}$

Table 3. Avalanche characteristics

Symbol	Parameter	Value	Unit
I_{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T_{jmax})	2.7	A
E_{AS}	Single pulse avalanche energy (starting $T_j = 25^\circ\text{C}$, $I_D = I_{AR}$; $V_{DD} = 50 \text{ V}$)	138	mJ

2 Electrical characteristics

$T_C = 25^\circ\text{C}$ unless otherwise specified

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(\text{BR})\text{DSS}}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	600			V
I_{DSS}	Zero gate voltage	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V}$			1	μA
	Drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V}, T_C = 125^\circ\text{C}^{(1)}$			100	μA
I_{GSS}	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$			± 10	μA
$V_{GS(\text{th})}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	3.25	4	4.75	V
$R_{DS(\text{on})}$	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 6.5 \text{ A}$		0.230	0.278	Ω

1. Defined by design, not subject to production test.

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz}, V_{GS} = 0 \text{ V}$	-	787	-	pF
C_{oss}	Output capacitance		-	50	-	
C_{rss}	Reverse transfer capacitance		-	1.2	-	
$C_{oss \text{ eq.}}^{(1)}$	Equivalent output capacitance	$V_{DS} = 0 \text{ to } 480 \text{ V}, V_{GS} = 0 \text{ V}$	-	89	-	pF
R_G	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	-	5.9	-	Ω
Q_g	Total gate charge	$V_{DD} = 480 \text{ V}, I_D = 13 \text{ A}, V_{GS} = 0 \text{ to } 10 \text{ V}$ (see Figure 15. Test circuit for gate charge behavior)	-	22	-	nC
Q_{gs}	Gate-source charge		-	3.5	-	
Q_{gd}	Gate-drain charge		-	10.5	-	

1. $C_{oss \text{ eq.}}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Table 6. Switching energy

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
E_{off}	Turn-off energy (from 90% V_{GS} to 0% I_D)	$V_{DD} = 400 \text{ V}, I_D = 2 \text{ A}, R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$	-	7.2	-	μJ
		$V_{DD} = 400 \text{ V}, I_D = 5 \text{ A}, R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$	-	20.4	-	μJ

Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 300 \text{ V}, I_D = 6.5 \text{ A}, R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$ (see Figure 14. Test circuit for resistive load switching times and Figure 19. Switching time waveform)	-	10.5	-	ns
t_r	Rise time		-	5.2	-	ns
$t_{d(off)}$	Turn-off delay time		-	41	-	ns
t_f	Fall time		-	8	-	ns

Table 8. Source-drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_{SD}	Source-drain current		-		13	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)		-		52	A
$V_{SD}^{(2)}$	Forward on voltage	$V_{GS} = 0 \text{ V}, I_{SD} = 13 \text{ A}$	-		1.6	V
t_{rr}	Reverse recovery time	$I_{SD} = 13 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}, V_{DD} = 60 \text{ V}$ (see Figure 16. Test circuit for inductive load switching and diode recovery times)	-	230		ns
Q_{rr}	Reverse recovery charge	$T_j = 150^\circ\text{C}$ (see Figure 16. Test circuit for inductive load switching and diode recovery times)	-	2.3		μC
I_{RRM}	Reverse recovery current		-	20		A
t_{rr}	Reverse recovery time		-	287		ns
Q_{rr}	Reverse recovery charge		-	2.9		μC
I_{RRM}	Reverse recovery current		-	20.2		A

1. Pulse width is limited by safe operating area
2. Pulsed: pulse duration = 300 μs , duty cycle 1.5%

2.1 Electrical characteristics (curves)

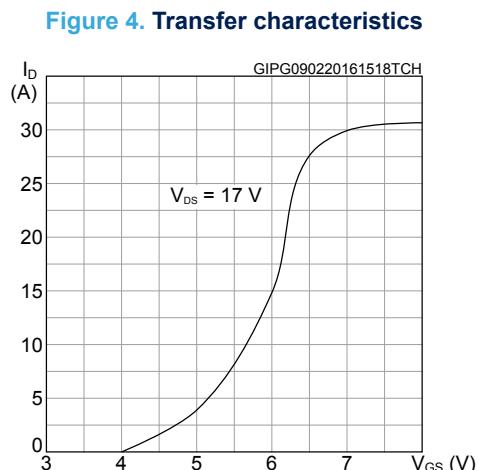
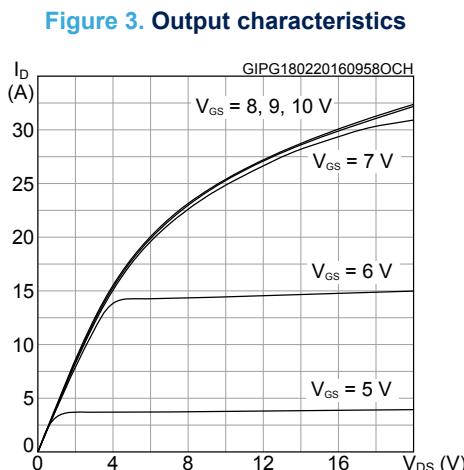
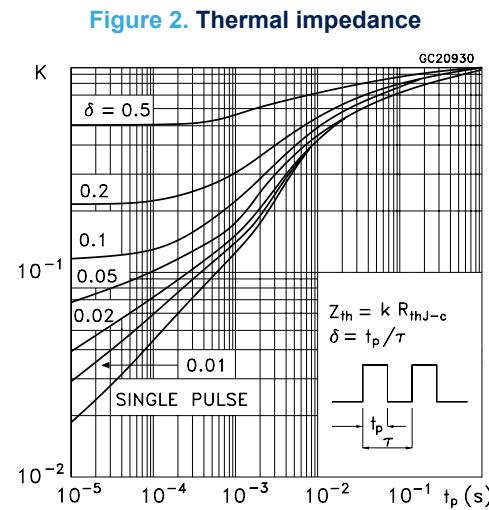
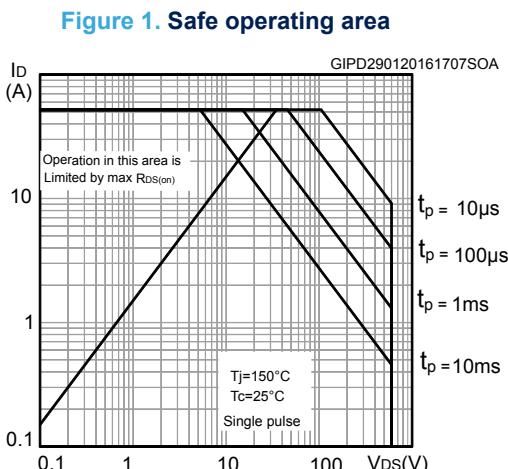


Figure 5. Gate charge vs gate-source voltage

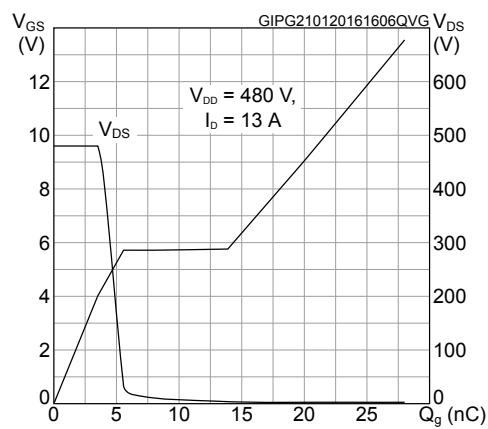


Figure 6. Static drain-source on-resistance

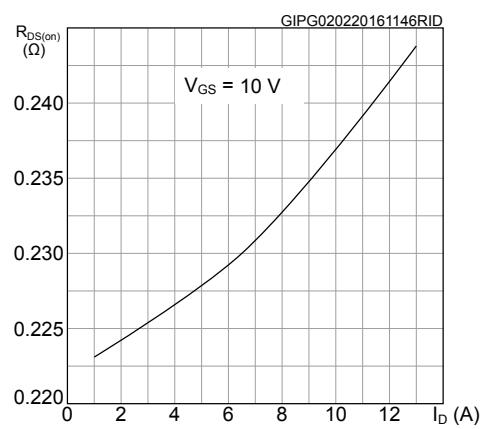


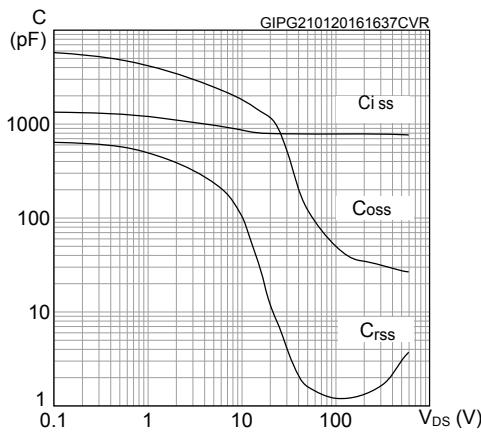
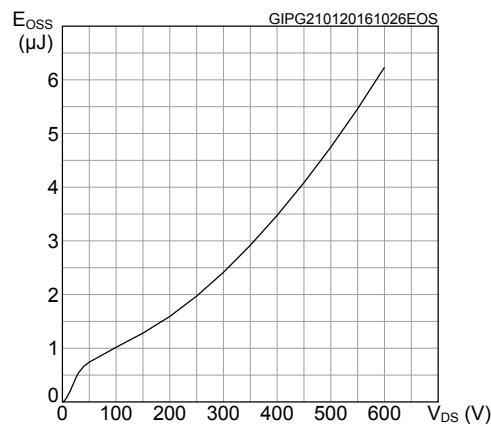
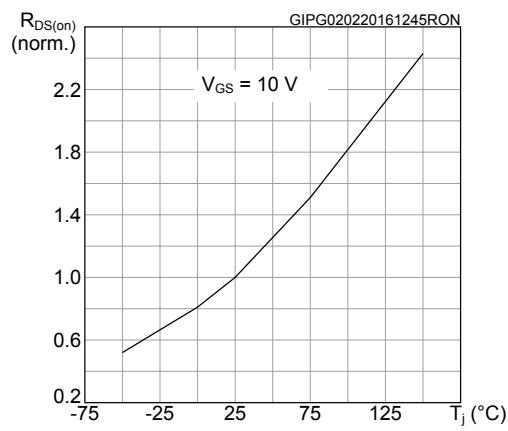
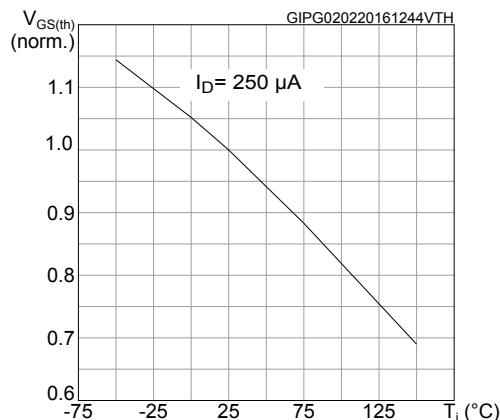
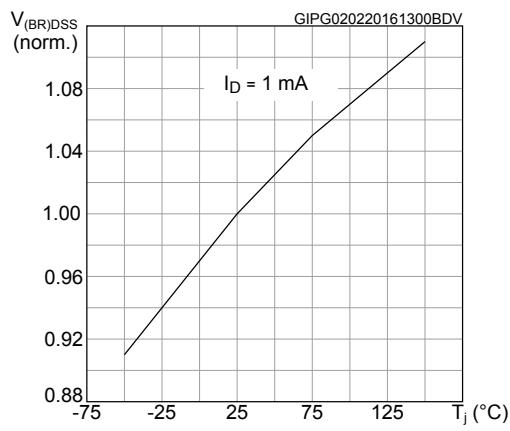
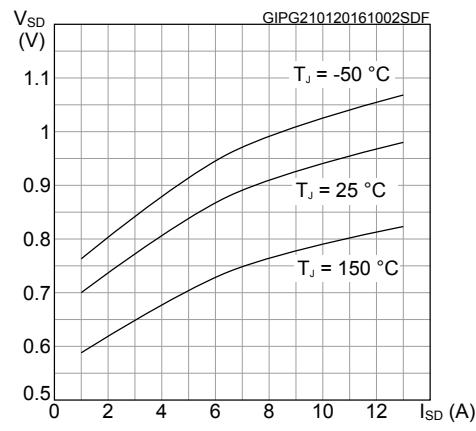
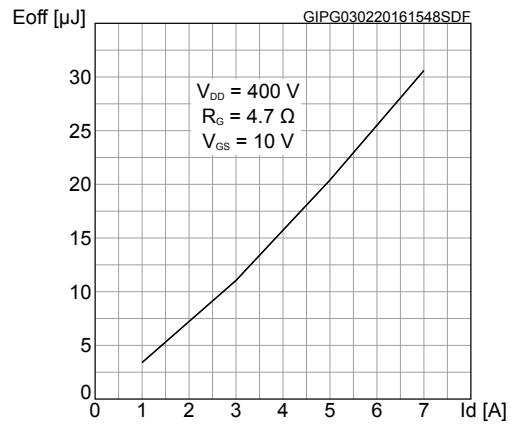
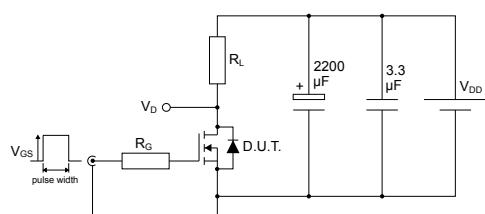
Figure 7. Capacitance variations

Figure 8. Output capacitance stored energy

Figure 9. Normalized on-resistance vs temperature

Figure 10. Normalized gate threshold voltage vs temperature

Figure 11. Normalized V_(BR)DSS vs temperature

Figure 12. Source-drain diode forward characteristics


Figure 13. Turn-off switching energy vs drain current



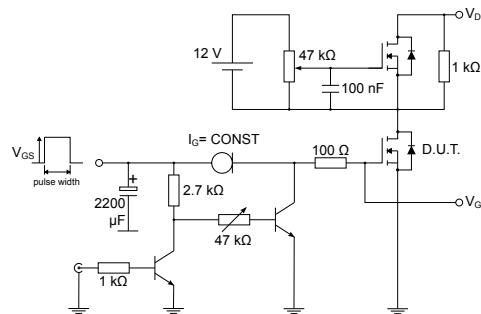
3 Test circuits

Figure 14. Test circuit for resistive load switching times



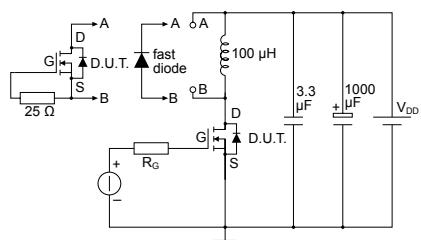
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Figure 15. Test circuit for gate charge behavior



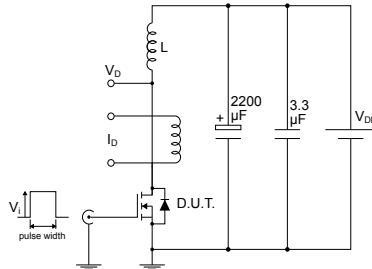
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Figure 16. Test circuit for inductive load switching and diode recovery times



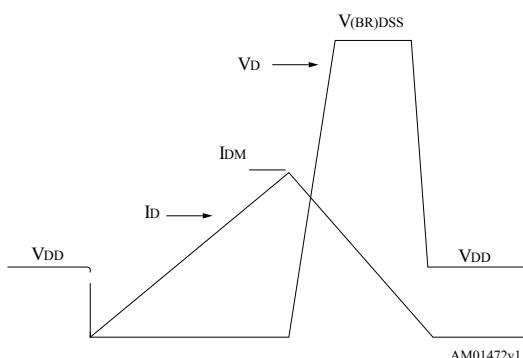
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Figure 17. Unclamped inductive load test circuit



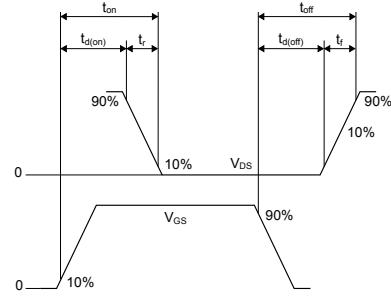
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Figure 18. Unclamped inductive waveform



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Figure 19. Switching time waveform



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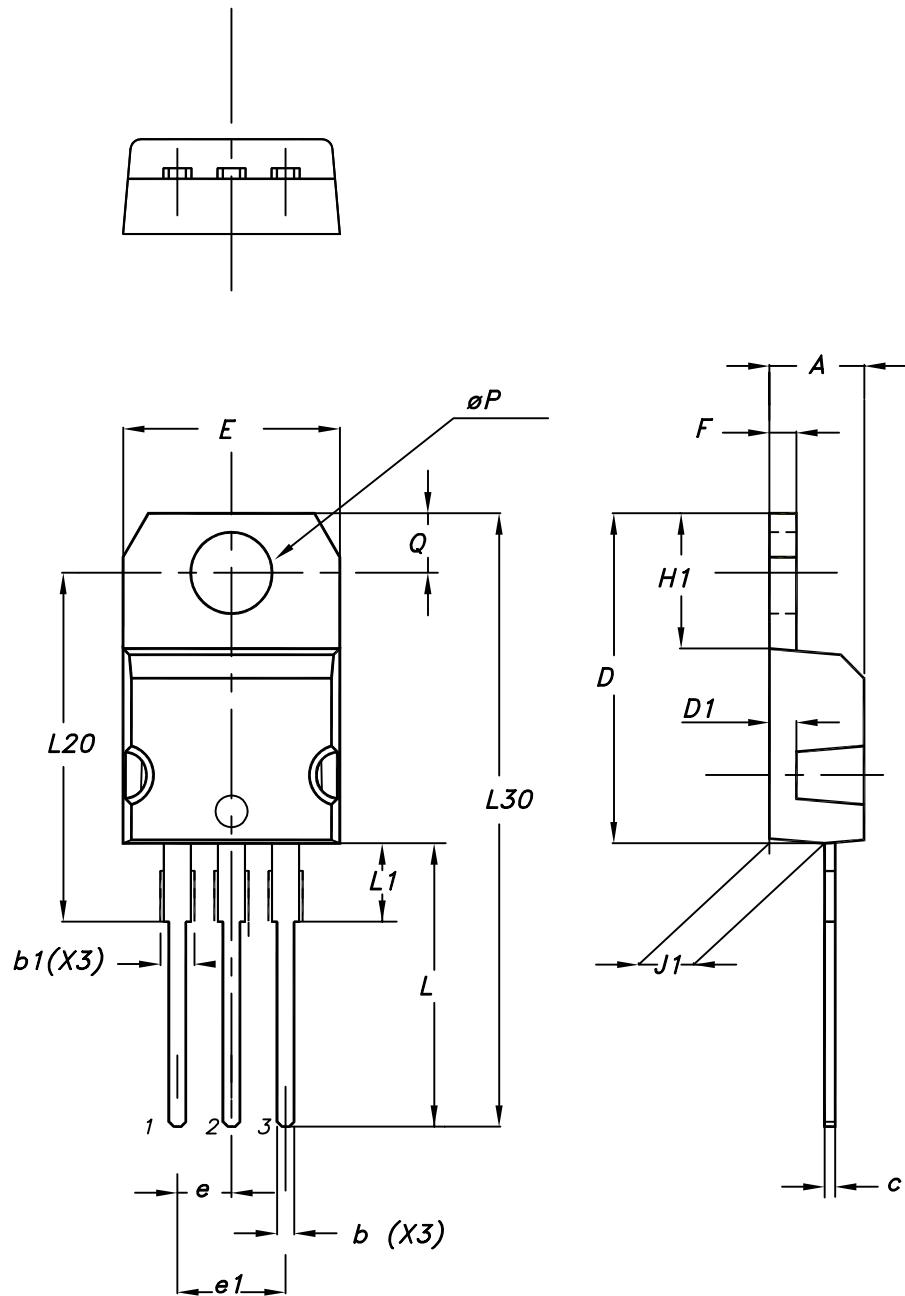
4

Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

4.1 TO-220 package information

Figure 20. TO-220 type A package outline



0015988_typeA_Rev_21

Table 9. TO-220 type A package mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.55
c	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10.00		10.40
e	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13.00		14.00
L1	3.50		3.93
L20		16.40	
L30		28.90	
øP	3.75		3.85
Q	2.65		2.95

Revision history

Table 10. Document revision history

Date	Revision	Changes
26-Feb-2016	1	First release.
16-Mar-2018	2	<p>The part numbers STI20N60M2-EP and STW20N60M2-EP have been moved in a separate datasheet. The document has been updated accordingly.</p> <p>Removed maturity status indication from cover page. The document status is production data.</p> <p>Updated <i>Section 1 Electrical ratings</i>, <i>Section 2 Electrical characteristics</i> and <i>Section 2.1 Electrical characteristics (curves)</i>.</p> <p>Minor text changes.</p>
04-Jun-2018	3	<p>Modified Table 1. Absolute maximum ratings and Table 8. Source-drain diode.</p> <p>Modified Figure 1. Safe operating area.</p> <p>Minor text changes.</p>

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